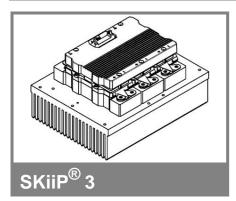
SKiiP 513GD122-3DUL



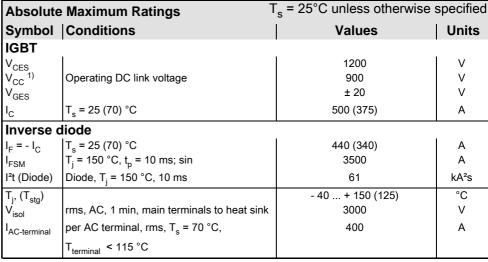
6-pack-integrated intelligent Power System

Power section SKiiP 513GD122-3DUL

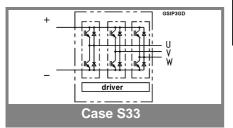
Data

Power section features

- SKiiP technology inside
- SPT (Soft Punch Through) IGBTs
- CAL diode technology
- Integrated current sensor
- Integrated temperature sensor
- Integrated heat sink
- IEC 60721-3-3 (humidity) class 3K3/IE32 (SKiiP® 3 System)
- IEC 60068-1 (climate) 40/125/56
- UL recognized file no. E63532
- 1) with assembly of suitable MKP capacitor per terminal



Characteristics		T _s = 25 °C unless otherwise specified					
Symbol	nbol Conditions			min.	typ.	max.	Units
IGBT							
V _{CEsat}	I _C = 300 A, T _j = 25 (125 measured at terminal) °C;			2,3 (2,5)	2,6	V
V_{CEO}	T _i = 25 (125) °C; at term	ninal			1,1 (1)	1,3 (1,2)	V
r_{CE}	T _j = 25 (125) °C; at term	ninal			3,8 (5)	4,5 (5,6)	mΩ
I _{CES}	$V_{GE} = 0 \text{ V}, V_{CE} = V_{CES},$ $T_i = 25 (125) ^{\circ}C$				1,2 (36)		mA
$E_{on} + E_{off}$	$I_{\rm C}^{\rm J}$ = 300 A, $V_{\rm CC}$ = 600 V	•			90		mJ
	$T_j = 125 ^{\circ}\text{C}, V_{CC} = 900 ^{\circ}$				159		mJ
R _{CC+EE}	terminal chip, T _j = 25 °C	;			0,5		mΩ
L _{CE}	top, bottom				12		nH
C _{CHC}	per phase, AC-side				1,7		nF
Inverse o							
$V_F = V_{EC}$	I _F = 300 A, T _j = 25 (125) measured at terminal) °C			1,8 (1,5)	2,3	V
V_{TO}	T _: = 25 (125) °C				1 (0,7)	1,2 (0,9)	V
r _T	T _j = 25 (125) °C T _i = 25 (125) °C				2,6 (2,8)	3,5 (3,7)	mΩ
Ė _{rr}	$I_{\rm C}^{\rm J}$ = 300 A, $V_{\rm CC}$ = 600 V	•			24		mJ
	$T_j = 125 ^{\circ}\text{C}, V_{CC} = 900 ^{\circ}$	V			31		mJ
Mechanical data							
M_{dc}	DC terminals, SI Units			6		8	Nm
M _{ac}	AC terminals, SI Units			13		15	Nm
W	SKiiP® 3 System w/o he	at sink			2,4		kg
W	heat sink				7,5		kg
Thermal characteristics (PX16 heat sink with fan SKF16B-230-1); "s" reference to heat sink; "r" reference to built-in temperature sensor (acc.IEC 60747-15)							
R _{th(j-s)I}	per IGBT					0,059	K/W
R _{th(j-s)D}	per diode					0,115	K/W
Z _{th}	R _i (mK/W) (max. values)						
	1 2		4	1	tau 2	3	4
$Z_{th(j-r)I}$	10,2 28,8	21	0	363	0,18	0,04	1
$Z_{\text{th(j-r)D}}$	36 36	54 6	0	30	5	0,25	0,04



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1,4

210

85

11

0,4

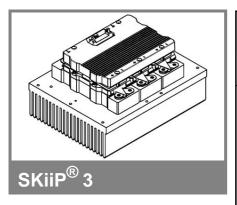
20

5,5

 $Z_{th(r-\underline{a})}$

2,1

SKiiP 513GD122-3DUL



6-pack-integrated intelligent Power System

6-pack integrated gate driver SKiiP 513GD122-3DUL

Data

Gate driver features

- · CMOS compatible inputs
- Wide range power supply
- Integrated circuitry to sense phase current, heat sink temperature and

DC-bus voltage (option)

- Short circuit protection
- Over current protection
- Over voltage protection (option)
- Power supply protected against under voltage
- Interlock of top/bottom switch
- Isolation by transformer
- IEC 60068-1 (climate) 40/85/56
- UL recognized file no. 242581

Absolute Maximum Ratings		T _a = 25 °C unless otherwise specified			
Symbol	Conditions	Values	Units		
V_{S2}	unstabilized 24 V power supply	30	V		
V_{i}	input signal voltage (high)	15 + 0,3	V		
dv/dt	secondary to primary side	75	kV/μs		
V_{isollO}	input / output (AC, rms, 2 s)	3000	V		
V _{isoIPD}	partial discharge extinction voltage, rms, Q _{PD} ≤ 10 pC;	1170	V		
V _{isol12}	output 1 / output 2 (AC, rms, 2 s)	1500	V		
f _{sw}	switching frequency	15	kHz		
f _{out}	output frequency for I _{peak(1)} =I _C	15	kHz		
$T_{op} (T_{stg})$	operating / storage temperature	- 40 + 85	°C		

Characte	eristics		= 25 °C)		
Symbol	Conditions	min.	typ.	max.	Units
V_{S2}	supply voltage non stabilized	13	24	30	V
I _{S2}	V _{S2} = 24 V	365+30*f/kHz+0,00111*(I _{AC} /A) ²		mA	
V_{iT+}	input threshold voltage (High)			12,3	V
V_{iT-}	input threshold voltage (Low)	4,6			V
R _{IN}	input resistance		10		kΩ
C _{IN}	input capacitance		1		nF
t _{d(on)IO}	input-output turn-on propagation time		1,3		μs
t _{d(off)IO}	input-output turn-off propagation time		1,3		μs
t _{pERRRESET}	error memory reset time	9		μs	
t _{TD}	top / bottom switch interlock time		3		μs
I _{analogOUT}	max. 5 mA; 8 V corresponds to 15 V supply voltage for external components		500		Α
I _{s1out}	max. load current			50	mA
I _{TRIPSC}	over current trip level (I _{analog} OUT = 10 V)		625		А
T_tp	over temperature protection	110		120	°C
U _{DCTRIP}	U _{DC} -protection (U _{analog OUT} = 9 V); (option for GB types)		900		V

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